

MOS INTEGRATED CIRCUITS μ PD1710G-027, μ PD1710G-227

PLL FREQUENCY SYNTHESIZER AND CONTROLLER FOR FM/MW TUNER

The μ PD1710G-027, μ PD1710G-227 (52 pin flat package) is a CMOS LSI circuit having a PLL frequency synthesizer and controller for FM/MW reception in the USA, Oceania and Japan.

A combination of the μ PD1710G-027, μ PD1710G-227 and μ PB553AC prescaler realizes a multifunction high-performance FM/MW digital tuning system, for use in car stereo, home stereo, or radio cassette recorder.

FEATURES

- The Japanese MW band has wide band range (522 to 1629 kHz) for automotive radio information
- Dynamic display on LED/FIP or static display on LCD/FIP (with μPD6320G/μPD6321G)
- Dot or digit display for preset memory
- Sufficient preset memory capacity for 18 FM stations (6 x 3) and 6 MW stations
- Auto tuning function (seek operation), manual tuning function, scan function for holding 5 seconds, and preset scan function for automatically receiving preset memory station for 5 seconds
- Optional functions such as LOCAL, LOUDNESS, METAL, Dolby NR*, STEREO, and AMS
- Complete lead muting to prevent popping sound caused by outputting a band selection signal from controller side
- Output of AGC-CUT signal to prevent malfunctions during autotuning
- Check tone output for key operation (with external oscillator)
- Dimmer function (for dynamic display)
- 12 hour timer function
- The following is compatible family of μPD1710G-027, μPD1710G-227

μPD1710G-213

for Europe, Dynamic display only

μPD1710G-015

for Europe, Static display only

μPD1710G-117

for South Africa, Dynamic/Static display

- 52 pins plastic flat package
- Selectable lead type

Lead bent type:

μPD1710G-027-00

Straight lead type:

μPD1710G-227-03

Dolby^R and the double-D symbol are registered trademarks of Dolby Laboratories Licensing Corporation.

FUNCTIONS

Received Frequency, Channel Spacing, Reference Frequency, and Intermediate Frequency

		T	77 Troducto I requestey				
AREA	BAND	FREQUENCY RANGE	CHANNEL SPACING	REFERENCE FREQUENCY	NUMBER OF CHANNELS	INTERMEDIATE FREQUENCY	
	FM	87.9 to 107.9 MHz	200 kHz	25 1.11-	101	10.700 MHz	
USA			100 kHz	25 kHz	201	10.725 MHz	
	MW	530 to 1 620 kHz	10 kHz	10 kHz	110		
		522 to 1 629 kHz	9 kHz	9 kHz	124	450 kHz	
Japan	FM	76.1 to 89.9 MHz	100 kHz	25 kHz	139	-10.700 MHz -10.675 MHz	
	MW	522 to 1 629 kHz	9 kHz	9 kHz	124	450 kHz	

Radio Functions

- (1) AUTO UP and AUTO DOWN (sawtooth wave mode)
- (2) MANUAL UP and MANUAL DOWN (sawtooth wave mode)
- (3) SCAN (up direction only)
- (4) PRESET SCAN
- (5) Preset memory for 18 FM stations (6 stations x 3) and 6 MW stations (24 stations total)
- (6) Last station memory for 3 FM stations and 1 MW station
- (7) LOCAL control output
- (8) LOUDNESS control output
- (9) STEREO control output (for both FM and AM)
- (10) AGC-CUT signal output during autotuning
- (11) Preset memory display (dot or digit)
- (12) Band selection method
 - (i) FM1, FM2, FM3, and MW keys
 - (ii) FM and MW keys (FM key for \rightarrow FM1 \rightarrow FM2 \rightarrow FM3 \rightarrow or \rightarrow FM1 \rightarrow FM2 \rightarrow)
 - (iii) BAND key (for → FM1 → MW¬)

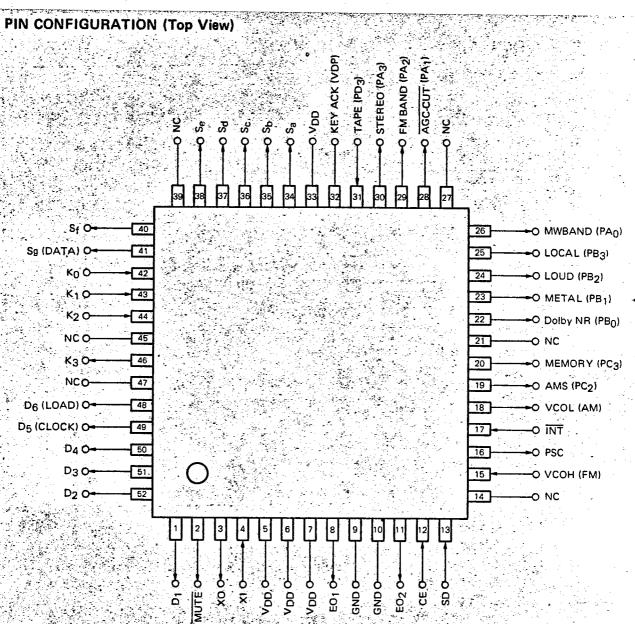
Cassette Tape Functions

- (1) METAL control output
- (2) Dolby NR control output
- (3) AMS control output
- (4) LOUDNESS control output

Timer Functions

- (1) 12-hour display (AM/PM is not displayed.)
- (2) Hours and minutes can be adjusted individually.

(Press the MEMORY and MANUAL UP , MANUAL keys simultaneously.)



PIN DESCRIPTION

PIN NO.	PIN SYMBOL	DESCRIPTION
		DESCRIPTION Active for Mills the second of t
2	MUTE	Active low (Kills the sound (popping) when the PLL is unlocked or the TAPE pin is set ON/OFF.) This pin goes to low level unconditionally when the CE pin goes to low level (backup state). (See the MUTE output timing chart for details.)
3 4	XO XI	Connect a 4.5 MHz crystal oscillator to these pins.
5 6 7 33	V _{DD}	Device power supply pins for supplying 5 V ± 10 % for operation. The voltage may be lowered to 2.5 V when the timer is not used (CLOCK is OFF) or for backup. The VDD falling time must be 500 ms or less; if longer, the internal power on reset circuit may not operate normally. VDD must be started from 0 V; otherwise normal operation will not be resumed.
8 11	EO ₁	Charge pump output pins for the PLL phase detector. Since the same signal is output to pins 8 and 11, these pins may be connected to the low pass filter (LPF) on either the FM or MW side.
9 10	GND .	Connect either or both of these pins to the system ground (GND).
12	CE	Device selection signal input pin. Set this pin at high level to operate the device or at low level when the device is unused. High level Normal operation Low level When CLOCK is ON, holds the memory, sets the display OFF, stops the PLL operation, and starts only the internal timer. When CLOCK is OFF, holds the memory, sets the display OFF, and stops all internal operations. The maximum backup current at this time is 10 µA. For an application not using the timer function, only a low current (a maximum of 10 µA) is necessary for memory backup when this pin is at low level. A high or low level signal less than 134 µs is not accepted. CE must be started from 0 V; otherwise, the internal reset circuit will not operate properly.
13	SD	Active high (Detects whether a broadcast station is detected during autotuning (SEEK UP, SEEK DOWN, or SCAN UP).) After PLL is locked, a high level signal must be input within 40 ms.
15	VCOH (FM)	This pin is used to input the signal obtained by dividing the FM station signal to 1/16 or 1/17 with the μ PB553AC prescaler. Since this pin is connected to an AC amplifier, isolate the DC with a capacitor.
16	PSC	Pulse swallow control output connected to the PSC pin of µPB553AC prescaler via C or R.
17	ĪNT	External interrupt input. Pull up to VDD because this pin is not used.
18	VCOL (AM)	MW station signal input. Since this pin is connected to an AC amplifier, isolate the DC with a capacitor.
19	AMS	This pin is interlocked with the AMS key. The output is reversed each time this AMS key pressed. The output is valid only when the TAPE pin is at high level (tape mode); otherwise, this pin is at low level.
20	MEMORY	When the MEMORY ENABLE key is pressed while the frequency is displayed (radio mode), the memory enters the write mode for approximately 5 seconds and this pin outputs a high level signal. Connect a driver to this pin to light the memory lamp. When STATIC display is selected, this is also displayed at the same time from the static driver side.
22 23	Dolby NR METAL	Pins 22 and 23 are interlocked with the Dolby NR and METAL keys respectively. Each time the Dolby NR or METAL key is pressed, the related output is toggled. The output is valid only when the TAPE pin is at high level (tape mode); otherwise, this pin is at low level.
24	LOUDNESS	This pin is interlocked with the LOUD key. Each time the LOUDNESS key is pressed, the output is toggled. This pin is always valid regardless of the TAPE pin state.

T	PIN NO.	DIN SYMBOL	DESCRIPTION
F	FIN NO.	PIN SYMBOL	
	25	LOCAL	This pin is interlocked with the LOCAL key, Each time the LOCAL key is pressed, the output
	25	LOUAL	is toggled. The output is valid only when the TAPE pin is at low level (radio mode); otherwise, this pin is at low level.
-			
	26	MW BAND	MW tuner control output. The output is at high level only when the TAPE pin is at low level (radio mode) and MW is selected; otherwise, this pin is at low level.
			When the SEEK DOWN , or SCAN key is pressed (autotuning), the following AGC-CUT
1			signal is output (active low). This signal stabilizes the STOP operation during autotuning.
			(ms)
_ -			[발전] [10] [10] [10] [10] [10] [10] [10] [10
ľ			MUTE output
1	28	AGC-CUT	SEEK UP, SEEK DOWN or SCAN UP key
1	20	AGC.COT	
1.			AGC-CUT output
1			25 c 250 c 275
- [SD=Low Low Low Low Low High
1			This signal may also be used as an autotuning indicator output.
ŀ		FM	FM tuner control output. The output is at high level only when the TAPE pin is at low level (radio
	29	BAND	mode) and FM is selected (FM1, FM2, or FM3); otherwise, this pin is at low level.
+	4		<u> </u>
1			This key is interlocked with the STEREO key. Each time the STEREO key is pressed, the output is toggled. The output is valid only when the TAPE pin is at low level; otherwise, this pin is at low
	30	STEREO	level.
			The STEREO output is valid when FM or MW is selected.
	31	TAPE	Input pin for setting the tape mode (high level) or radio mode (low level).
	32	KEYACK	This pin is at high-level for approximately 40 ms after the controller accepts a key input. A key
1	4		click can be generated by connecting an external oscillator.
	34	. Sa ∗	
1	35	S _b	
	36	S _C	For dynamic display (when STATIC is OFF)
	37	· S _d	Active high (display segment signal outputs and key return signal sources)
1	38	Se	For static display (when STATIC is ON)
1	40	S _f	Active high (serial data output (Sg only) to static driver and key return signal sources)
	41	S _g (DATA)	
F	42		
	42 43	Ko	Key return signal input from key matrix
	44	K ₁ K ₂	New return signal input from key matrix. Pull down this pin with a resistor of approximately 22 k Ω to enhance reading at low level.
1	46	K3	The section was properties a resistor or approximately 22 has to emissing a row level.
-		X40	[1] - 사용 보고 있는 사용 전략 생각이었다. 생각이 되는 사람들이 사용하게 하는 사람들이 되는 것이 하게 하는 것이다. 사용하는 것이 되었다. 사용하는 것이 되었다. 그런 그는 사용하는 사용하는 것이 되었다. 그런 그는 사용하는 것이 되었다. 그런
1	48	D6 (LOAD)	
	49	D ₅	For dynamic display (when STATIC is OFF)
1	7	(CLK)	Active high (display character signal outputs and key return signal sources (D ₁ to D ₃)
	50	D ₄	For static display (when STATIC is ON)
	51	D ₃	Active high (clock output (D _B) and strobe output (D _B) to static driver and key return signal
	52	D ₂	sources (D ₁ to D ₃)
		D ₁	

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1. KEY MATRIX

1.1 CONFIGURATION OF KEY MATRIX

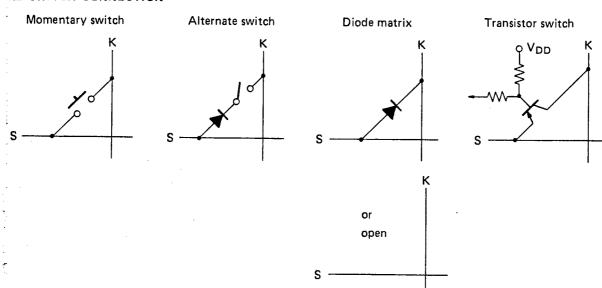
INPUT OUTPUT	K3 (46)	K ₂ (44)	K ₁ (43)	K ₀ (42)
S _a (34)	SEEK UP	SEEK DOWN	SCAN UP	AMS
S _b (35)	MANUAL UP	MANUAL DOWN	M5	M6
S _c (36)	M1	M2	М3	M4
S _d (37)	LOCAL	LOUD	METAL	Dolby NR
S _e (38)	RECALL	PRESET SCAN	MEMORY ENABLE	STEREO
S _f (40)	FM FM1 BAND	FM2	FM3	MW
S _g (41)	DIMMER	FMSEL1	FMSEL2	PRIO
D ₁ (1)		MWSEL	BAND1	BAND2
D ₂ (52)	IF ·	CLOCK	CHDISP	STATIC
D ₃ (51)	BLANK			

Momentary switch

Alternate or transistor switch

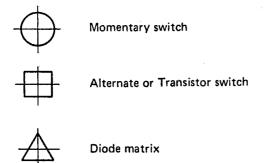
Diode matrix (Diode short circuit)

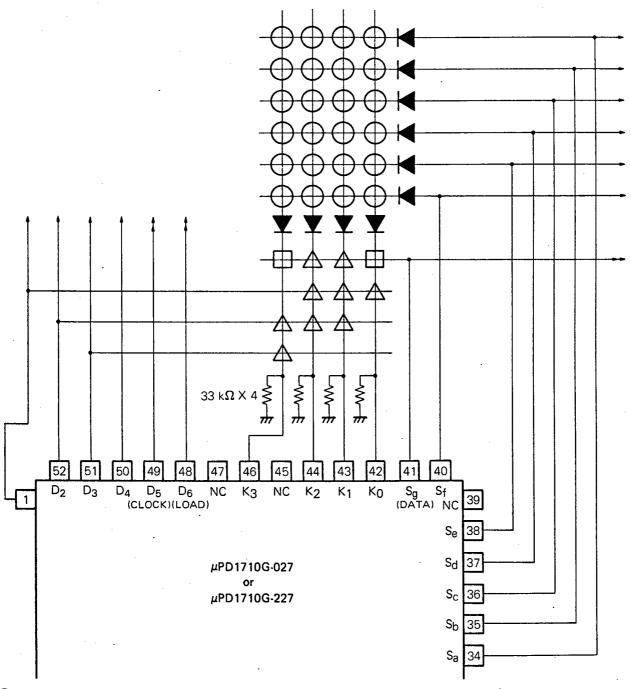
1.2 SWITCH CONNECTION



1,3 KEY MATRIX CONNECTION

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1.4 DESCRIPTION OF KEY MATRIX

1.4.1 INITIALIZATION DIODE SWITCHES

There are 10 initialization diode switches. They are read when the V_{DD} pin is first powered (power on reset) or when the CE pin goes to high level (CE reset). The switch settings are ignored in all other states.

A switch is set by closing (ON) or opening (OFF) a matrix crosspoint with a diode.

(1) FM band area setting switches

FMSEL1, FMSEL2

(2) MW band channel spacing setting switch MW-SEL

(3) FM IF setting switch

IF

(4) The timer function setting switch

CLOCK

(5) Band selection method setting switches

BAND1, BAND2

(6) Preset memory display setting switch

CH-DISP

(7) Static or dynamic display setting switch

STATIC

SYMBOL				FUNCTION						
	FM band area setting switches									
	FMSEL1	FMSEL2	AREA	FREQ	JENCY RANG	E CHANNE	L SPACING			
	0	0	USA	87.9	to 107.9 MHz	20	0 kHz			
FMSEL1	0	1	Japan	76.1	to 89.9 MHz	10	0 kHz			
FMSEL2	1	0	Oceania	87.9	to 107.9 MHz	10	0 kHz			
	* 1	1	_		_					
	Do not set set correctl		SEL1 and FM	SEL2 switch	es simultaneou	sly; if you do, the l	band (area) cannot b			
	MW band ch	annel space	setting swite	ch,						
MW-SEL	MWSEL	FR	FREQUENCY RANGE		CHANNEL SPACING		7			
	0		530 to 1 620 kHz		10 kHz					
	1		522 to 1 629 kHz		9 kHz					
	FM IF setting switch									
IF	IF	IF USA		JAPAN OCEA		OCEANIA				
	0	10.70	0.	-10.700 10.		10.700				
	1	10.725		-10.675 10.7		10.725				
	Switch for s	etting wheth	er to use the	e timer fun	ction.					
	CLOCK	TIM	TIMER FUNCTION				•			
CLOCK	0	0 Unu								
ou ou o	1		Used				•			
	When using PRIO and B			OCK=OFF	, set the disp	olay mode by a	combination of th			

SYMBOL	FUNCTION									
	Band (FM1, FM2, FM3, or MW) selection method setting switches.									
-	BANDI	BAND1 BAND2 KEYS USED			USABLE BANDS					
	BAND1 BAND2 KEYS USED			FM1	FM2	FM3	MW			
	0	0 .	FM MW FM1 FM2 MW FM1 FM2 FM3 MW		0	0	0 0			
BAND1 BAND2	1	1	FM MW → FM1 → FM2—	0	0		0			
	0	1	FM MW → FM1 → FM2 → FM3 →		0	0	0			
	1	0	BAND FM1 → MW	0			0			
	Note: Ff		, and BAND indicate the same key at t	the crosspoint of	Sf and K	3. In this e	xplanation,			
CHDISP	memory. Use this	switch fo	splay setting switch. A dot or digital response of the properties							
	Switch fo		static or dynamic display DISPLAY SETTING Dynamic display Static display				-			
STATIC	side to the	the µPD6 ne driver s : Display	$6320G/\mu$ PD6321G external static draide via the CLOCK (D ₅), DATA (Sgorising Sa to Sg and D ₁ to D ₅ for dy), and LOAD	(D ₆) pins		controller			



SYMBOL	FUNCTION				
	in other than th	ing whether to display bland the timer priority display modes to and TAPE input=high	k or the timer when tape is loaded (TAPE pin=high) de (PRIO=0).		
5. 44116	BLANK	DISPLAY STATE			
BLANK	0	Timer display			
	1	Display OFF (blank)			
		loaded (TAPE input=high)	in the timer priority display mode (PRIO=C dless of the BLANK switch state.		

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1.4.2 ALTERNATE SWITCHES

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DIM and PRIORITY are alternate switches. Unlike switches for initial setting, these alternate switches may be used at any time.

SYMBOL	FUNCTION					
	Switch for chan	nging (4:1) the display intensity for dynamic display (STATIC=0).				
DIM	DIM	DISPLAY INTENSITY				
	0	Bright (duty 1/8)				
Diw	1 Dark (duty 1/32)					
	For static dispignored.	play (STATIC=1), the DIM function is unusable and the DIM switch state is				
	Switch for setti	ing timer display priority mode				
2010	PRIORITY	DISPLAY MODE				
PRIO	0	No priority for timer display				
	1	Priority for timer display				

1.4.3 MOMENTARY SWITCHES AND FUNCTIONS

There are 24 momentary switches:

SYMBOL	FUNCTION
SEEK UP SEEK DOWN	Autotuning keys. A broadcast station is scanned in the up or down direction in the sawtooth mode until the SD pin goes to high level; once the SD pin goes to high level, this frequency is held. Autotuning can be stopped by pressing this key twice, regardless of the SD pin state. Static display: 38 ms/step Dynamic display: 42 ms/step
MANUAL UP MANUAL DOWN	Manual tuning key. The frequency is increased or decreased by one step each time this key is pressed. If this key is held down for 0.5 second or more, the station frequency is scanned at high speed. The speed varies according to the band. (Sawtooth wave mode) Static display : 38 ms/step (FM/MW) Dynamic display : 42 ms/step (FM/MW) During timer display, these keys are used for time adjustment. The minute or hour can be adjusted by pressing the MANUAL OF MANUAL DOWN key together with the MEMORY ENABLE
SCAN UP	Autoscanning key. A broadcast station frequency is sought in the up direction in the sawtooth wave mode until the SD pin goes to high level. When the SD pin goes to high level, this frequency is held for 5 seconds, then the next broadcast station frequency is sought. This operation continues until a key operation is performed. Autoscanning can be stopped by pressing the SCAN key twice. The scan speed is the same as when the SEEK UP key is pressed.
PRESET SCAN	Key for automatically calling the preset memory for 5 second period. Like a SCAN key operation continues until a key operation is performed. To stop scanning at the specified preset channel during 5 second holding, press the RESET SCAN key again; or check the channel display, then press the necessary preset memory key (M1 to M6). If this key is pressed while receiving the preset memory, scanning starts from the next memory; if this key is pressed while receiving a broadcast frequency not in the preset memory, scanning starts from M1. When this PRESET key is pressed, the preset memory is called unconditionally in the sequence of $\rightarrow M1 \rightarrow M2 \rightarrow M3 \rightarrow M4 \rightarrow M5 \rightarrow M6 \rightarrow M6 \rightarrow M1$. This key must not be used in application having fewer than six preset buttons.
MEMORY ENABLE	Key for writing new frequency in the preset memory. When this key is pressed, the ME display is on for approximately 5 seconds (the MEMORY output remains at high level for approximately 5 seconds). Press one of the M1 to M6 keys, then write the new frequency during this period of time. If no key operation is performed during the 5 seconds, the ME display goes OFF and frequency writing is disabled. To reset the memory write mode before 5 seconds lapse, press the MEMORY key again or press any key other than the M1 to M6 keys. During timer display, this key is used for time adjustment. The minute or hour can be adjusted by pressing the MANUAL DOWN key while pressing the MEMORY ENABLE key.

MW frequencies).

M4

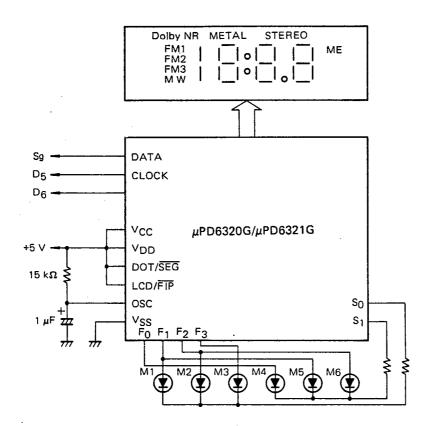
M5 M6 When the V_{DD} is first powered, the lowest frequency of the band is written in the memory.

LCD/FIP Static Display (STATIC=1)

Use μ PD6320G/ μ PD6321G static driver.

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(For static LCD)



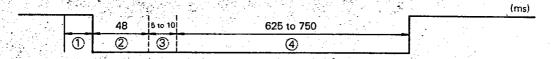
Flag Explanations (µPD6320G/6321G)

FLAG	PIN NUMBER	DISPLAYED CONTENT	
D ₁	. 26	MW	
D ₂	27	FM2	
D ₃	28	FM1	
D4	29	(Highest digit position)	
D ₅	4	Dolby NR	
D ₆	5	METAL	
D7	6	FM3	
D ₈	8	ME	
Dg	13	STEREO	
D ₁₀	18	D.P.	
D ₁₁	22	COLON	

3. TIMING CHART (MUTE OUTPUT (ACTIVE LOW) TIMING CHART)

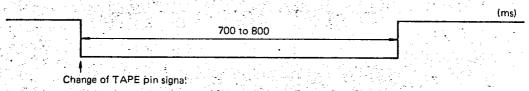
- (1) Key debounce time (approximately 15 ms)
- (2) MUTE leading time
- 3 Time for setting the frequency division ratio and updating display contents
- 4 MUTE trailing time
- (5) Wait time before SD pin signal detection
- 6 Wait time before PLL lock (This value varies according to the constant of external LPF and so forth.)

(1) When the receiving band is changed (FM/MW)

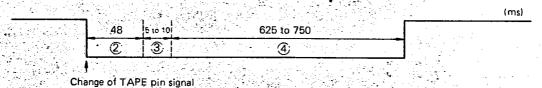


(2) When the TAPE pin output is changed

(i) Low (RADIO) → High (TAPE)



(ii) High (TAPE) → Low (RADIO)



(3) When preset memory is called

(1965) 이 사람들이 되었다. -				(ms)
	48	5 to 10	250 to 375	
0	2	3		

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(ms)

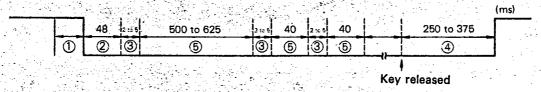
(4) When MANUAL UP

MANUAL key is pressed

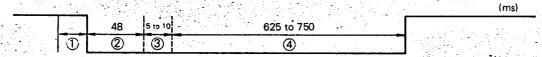
(i) When the key is pressed not longer than 500 ms (step scanning)

<u> </u>					<u> </u>
75 10 x		48 5 to	10	250 to 375	
	1	2 3)	(4)	

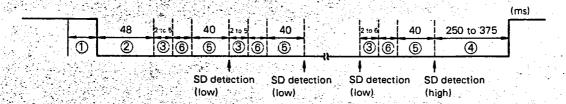
(ii) When the key is pressed 500 ms or more (fast scanning)



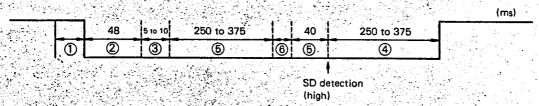
(iii) Band edge (upper limit → lower limit, lower limit → upper limit)



- (5) When SEEK , SEEK DOWN key is pressed
 - (i) Normal



(ii) Band edge (upper limit → lower limit, lower limit → upper limit)

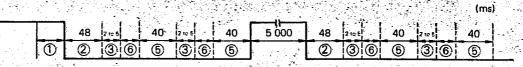


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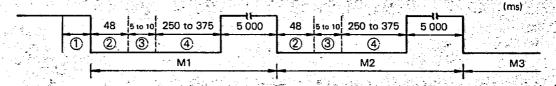
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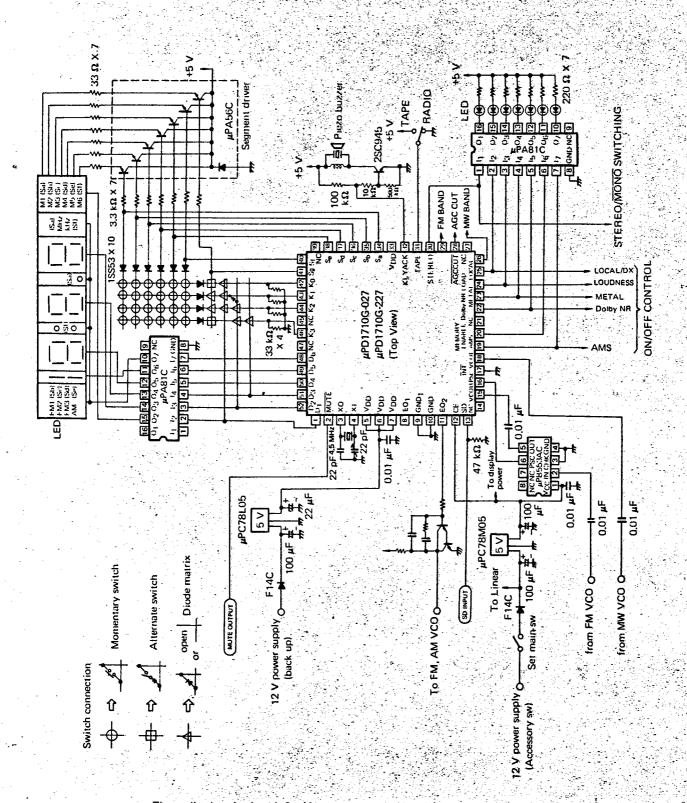




(7) When RESET Key is pressed



4. APPLICATION CIRCUIT



The application circuit and circuit constant presented in this report are not for mass production taking parts deviation or temperature characteristics into consideration. For patent regarding the circuits in this report, NEC does not bear any responsibility.

5. ELECTRICAL CHARACTERISTICS

5.1 ABSOLUTE MAXIMUM RATINGS ($T_a = 25$ °C)

Power Supply Voltage	V_{DD}	-0.3 to +6.0	٧
Input Voltage	V_1	-0.3 to +V _{DD}	٧
Output Voltage	Vo	-0.3 to +V _{DD}	٧
Output Absorption Current	Io	10	mΑ
Operating Temperature	Topt	-35 to +75	°C
Storage Temperature	T _{stg}	-35 to +125	°C

5.2 RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
Power Supply Voltage	VDD	4.5	5.0	5.5	٧	CE=High
	VDDH	2.5	 	5.5	V	No Clock mode (CLOCK=0) and CE=Low
Data (RAM) Hold Voltage		3.8	5.0	5.5	V	Clock mode (CLOCK=1) and CE=Low
Power Supply Voltage	VDDC	3.6	5.0		ļ	V _{DD} =0 → 4.5 V
Power Voltage Rise Time	trise			500	ms	VDD-0 - 4.5 v



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5.3 DC CHARACTERISTICS (V_{DD} =+4.5 to +5.5 V; T_a =-35 to +75 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
High Level Input Voltage	V _{IH1}	0.8 V _{DD}		V _{DD} .	٧	SD pin
High Level Input Voltage	V _{IH2}	0.7 V _{DD}		V _{DD}	V	I/O port and CE pin (see Note)
High Level Input Voltage	VIH3	0.6 V _{DD}		V _{DD}	>	K0 to K3 pins
Low Level Input Voltage	VIL1	0		0.3 V _{DD}	v	I/O port and CE pin (see Note)
Low Level Input Voltage	V _{IL2}	0		0.2 V _{DD}	v	K0 to K3 and SD pins
High Level Output Voltage	Voн1	4.0			٧	EO1 and EO2 pins I _{OH} =-0.5 mA
High Level Output Voltage	V _{OH2}	4.0			٧	D ₁ to D ₆ , MUTE, I/P port (see Note) I _{OH} =-0.2 mA
High Level Output Voltage	∨онз .	3.0			, v	PSC pin IOH=-0.1 mA
High Level Output Voltage	VoH4	3.0			٧	Sa to Sg pins I _{OH} =0.5 mA
Low Level Output Voltage	VOL1			0.5	٧	EO1 and EO2 pins, and I/O port (see Note) I _{OL} =0.5 mA
Low Level Output Voltage	V _{OL2}			0.5		D_1 to D_6 , MUTE, and PSC pins I_{OL} =0.2 mA
High Level Input Current	^{+l} IH1	10	40	100	μΑ	K0 to K3 pins V _{IN} =V _{DD} =5.5 V
High Level Input Current	+11H2		300		μА	XI pin (for pulling down) V _{IN} =V _{DD} =5.0 V
Low Level Input Current	-IIL1		300		μА	AM and FM pins (for pulling up) V_{IN} =0, V_{DD} =5.0 V
Output Leakage Current	IL.		10-3	1	μA	EO1 and EO2 pins (T _a =25 °C) V _{IN} =0, V _{DD} =5.0 V
Working Current	IDD1		3		mA	Except I/O current from I/O pins
Data (RAM) Hold Current	IDD2	j		10	μΑ	No Clock mode (CLOCK=0) and CE=0 T_a =25 $^{\circ}$ C, V_{DD} =5:0 V
Timer Current	IDD3		0.6		mA	Clock mode (CLOCK=1) and CE=0 , V _{DD} =5.0 V

Note: I/O port means the KEY ACK, TAPE, STEREO, FM BAND, AGC CUT, MW, LOCAL, LOUDNESS, METAL, Dolby NR, MEMORY, and AMS pins.

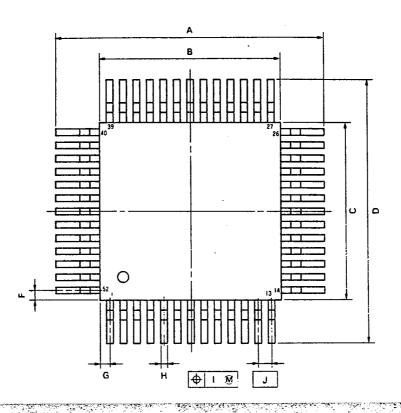
5.4 AC CHARACTERISTICS (V_{DD} =+4.5 to +5.5 V; T_a =-35 to +75 °C)

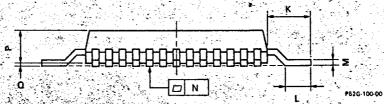
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
Operating Frequency	fAM	0.5		2.5	MHz	AM pin, V _{in} =1.0 V _{p-p} (MIN.), DC cut
Operating Frequency	fFM	0.5		8.8	MHz	FM pin, V _{in} =0.8 V _{p-p} (MIN.), Square wave, DC cut

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6. PACKAGE DIMENSIONS (Unit: mm) μPD1710G-027-00





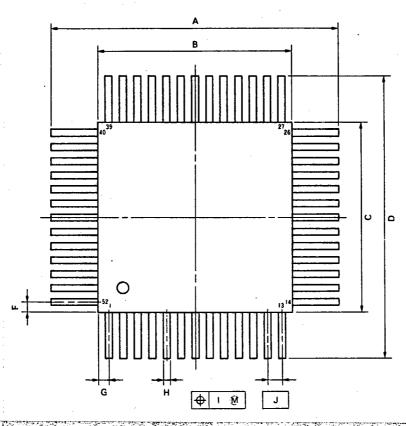
NOTE

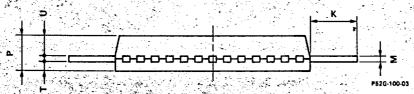
Each lead centerline is located within 0.20 mm (0.008 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
A	21.0 -0 -	O 827 · 0016
В	14.62	0.551 888
, c	14 07	0.551 888
D	21.0 04	0.827 -0016
F	1.0	0 039
G .	5.1.0	0.039
H 🐪	0.40***	0 016 88
1	0.20	0.008
J.	10 (T.P.)	0.039 (T.P.) **
K , 4 1	3.5 -67	0.138 888
1.1	22.62	0.087 888
M	0 15 8 %	0 006 8883
N .	0 15	0 006
Р /	26 81	0 102 888
0	0.1.81	0.004.000
		

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Each lead centerline is located within 0.20 mm (0.008 inch) of its true position (T.P.) at

ITEM	MILLIMETERS	INCHES
A	19.8:04	0 780 8815
В.	14.67	0.551 888
C -	14.62	0.551 888
D ·	19 8 - 04	0.780 8819
F	- 1.0	0.039
G	4 10	0.039
Н ,	0 40 .0 .0	0 016 888
<u>, , ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ;</u>	020	0.008
ا لر	1.0 (T P)	0.039 (T.P.)
ĸ	2.9 -02	0.114 888
M	,0 15 °8 kg	0 006 8885
P	26.83	0 102 888
, T	- 1.0	0.039
U >	1 45	0.057